

N800B

Non-Silicone Thermal Conductive Pad

Non-Silicone Thermal Compound N800B is made of non-silicon resin material and none low-molecular-weight siloxane. N800B helps avoid electrical contact problems. N800 is flexible and has great thermal conduction, making the thermal resistance as low as possible. The thermal conductivity is 13.0W/m*K. It's suitable for optical and sensitive electric components.

Features-

- Thermal conductivity: 13.0 W/m*K
- It's made of non-silicon resin materials
- Non-volatile, none Low-molecular-weight siloxane
- Low contact thermal resistance
- Electrical Insulation

Typical Applications-

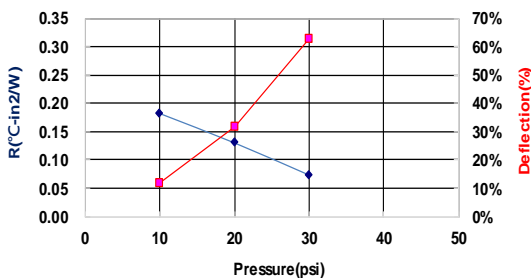
- Applicable for optical and sensitive electrical components

Specifications-

- Sheet form
- Die-cut parts



Thermal Resistance vs. Pressure vs. Deflection



Typical Properties-

PROPERTY	N800B	TEST METHOD	UNIT
Color	Gray	Visual	-
Surface tack	2-side/1-side	2	-
Thickness	Customized	ASTM D374	mm
Density	3.3	ASTM D792	g/cm ³
Hardness	50	ASTM D2240	Shore OO
Application temperature	-60~125	-	°C
ROHS&REACH	Compliant	-	-

COMPRESSION@1.0mm

Deflection @10 psi	12	ASTM D5470 modify	%
Deflection @20 psi	32	ASTM D5470 modify	%
Deflection @30 psi	63	ASTM D5470 modify	%

ELECTRICAL

Dielectric breakdown	8	ASTM D149	KV/mm
Surface resistivity	>10 ¹¹	ASTM D257	Ohm
Volume resistivity	>10 ¹⁰	ASTM D257	Ohm-m

THERMAL

Thermal Conductivity	13.0	ASTM D5470	W/m*K
Thermal impedance@10 psi	0.183	ASTM D5470	°C-in ² / W
Thermal impedance@20 psi	0.131	ASTM D5470	°C-in ² / W
Thermal impedance@30 psi	0.074	ASTM D5470	°C-in ² / W

Oil Bleeding-

Size 30*30mm²
 Thickness 1.0mm
 Compression 50%
 Temperature 25°C
 Time 120h



The chemical formula indicates that if Cyclic polydimethylsiloxane (HO-【Si(CH₃)₂O】_n-H) is non-reaction, it's volatile anytime and everywhere.

For example, when the electric products which has been put in a confined space, the volatile of low-molecular-weight siloxanes will makes the electric products uncontacted.